

High Power Multi-Tiered Conductor Hybrid Circuit Substrate



Product may not be to scale

FEATURES

- Copper power lines up to 5000 microinches thick
- Gold small signal lines ± 100 microinches width tolerance
- Temperatures to 350 °C
- Substrate material: Alumina, Beryllium Oxide or Aluminum Nitride
- Excellent adhesion
- Metallized through holes
- Filled vias
- Resistors available
- Sizes up to 4 inches x 4 inches

Vishay Electro-Films (EFI) has developed a thin film process that has the unique capability of incorporating up to 5000 microinches thick plated copper conductors on the same substrate with standard 100 to 300 microinches thick conductors.

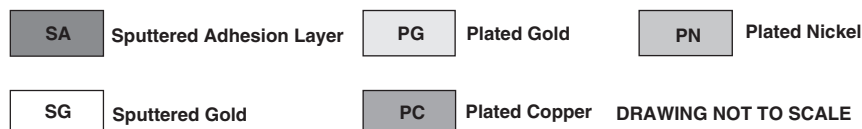
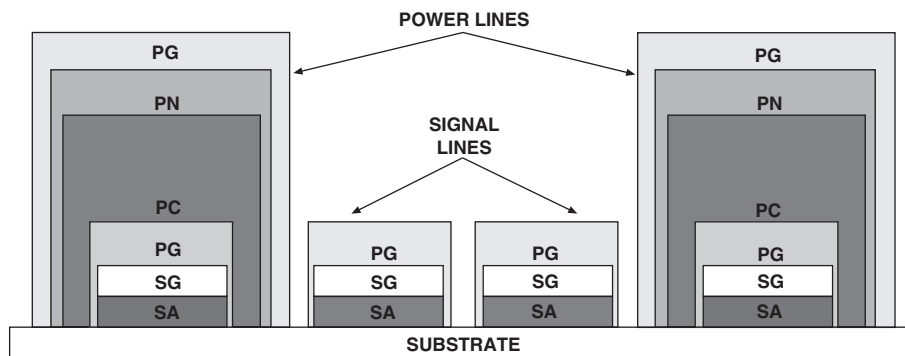
Some hybrid circuit applications require thick copper conductors for the power lines but standard thickness small signal lines to maintain tight line width control of critical elements. For example, a microwave application may require high power bias current to GaAs or other semiconductor devices while also requiring tight line width control to obtain good high frequency performance for large couplers, filters or other critical signal patterns.

For standard, high power, low frequency hybrid circuit substrates, thick copper plating alone is ideal. The 5000 microinches thick plated copper has a resistivity of less than 0.15 mΩ/square.

In most cases, the dc or low frequency copper power lines are overplated with nickel and gold to prevent oxidation, permitting high temperature processing and operation. The conductor material for the small signal lines is normally gold. Several substrate materials and various adhesion metals are available.

Consult Applications Engineer to discuss your requirements in detail to jointly develop the optimum metalization structure for your application.

TYPICAL CROSS SECTION



METALLIZED WAFERS



Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.